CMUD4448

SURFACE MOUNT HIGH SPEED SILICON SWITCHING DIODE



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMUD4448 type is an ultra-high speed silicon switching diode manufactured by the epitaxial planar process, epoxy molded in an ULTRAmini™ surface mount package, designed for high speed switching applications.

MARKING CODE: DAA



MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	V_{R}	75	V
Peak Repetitive Reverse Voltage	V_{RRM}	100	V
Continuous Forward Current	Ι _Ε	250	mA
Peak Repetitive Forward Current	I _{FRM}	500	mA
Peak Forward Surge Current, tp=1.0µs	I _{FSM}	4.0	Α
Peak Forward Surge Current, tp=1.0s	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	250	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	$\Theta_{\sf JA}$	500	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

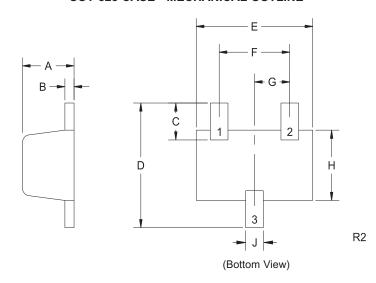
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_{R}	V _R =20V		25	nA
BV_R	I _R =5.0μA	75		V
BV_R	I _R =100μA	100		V
VF	I _F =5.0mA	0.62	0.72	V
V_{F}	I _F =100mA		1.0	V
C_T	$V_R=0$, f=1.0MHz		4.0	pF
t _{rr}	$I_R = I_F = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω		4.0	ns

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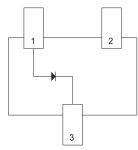
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SOT-523 CASE - MECHANICAL OUTLINE



PIN CONFIGURATION



DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.023	0.031	0.58	0.78		
В	0.002	0.008	0.04	0.20		
С	0.013	0.021	0.34	0.54		
D	0.059	0.067	1.50	1.70		
E	0.059	0.067	1.50	1.70		
F	0.035	0.043	0.90	1.10		
G	0.020		0.50			
Н	0.031	0.039	0.78	0.98		
J	0.010	0.014	0.25	0.35		

SOT-523 (REV: R2)

LEAD CODE:

- 1) Anode
- 2) No Connection3) Cathode

MARKING CODE: DAA

R3 (9-February 2010)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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